

1. (currently amended) A method for precisely aligning at least two parts of an electronic device, each part of said electronic device comprising at least three pads, each one pad, of said at least one padthree pads of a first of said at least two parts being aligned with one of said at least one padthree pads of a second of said at least two parts when said first and second parts are aligned, forming at least one pairthree pairs of pads, said method comprising the steps of:

- ____ depositing glue on said at least one padthree pads of a first part of said at least two parts,
- ____ aligning approximately said second part to said first part, and,
- ____ lying said second part on said first part.

2. (original) The method of claim 1 further comprising the step of reducing said glue to a liquid state.

3. (currently amended) The method of either claim 1 or claim 2 wherein the pads of at least one of said at least one pairthree pairs of pads are of different sizes.

4. (currently amended) The method according to any one of claims 1 to 3 wherein the shape of said the pads of at least one pad of one of said at least two partsthree pads is rectangular.

5. (currently amended) The method of any one of claims 1 to claim 4 wherein the shape of the pads of at least two pads of one of said at least two partsthree pairs of pads are rectangular and wherein the angle formed by their longer edges is approximately equal to 90°.

6. (currently amended) The method according to any one of claims 1 to 5 wherein the shape of said the pads of at least one pad of one of said at least two partsthree pairs of pads is annular.

7. (currently amended) The method of ~~any one of the previous claims~~claim 1 wherein the shapes of the pads of a same pair of pads are similar.

8. (currently amended) The method of ~~any one of the previous claims~~claim 1 wherein at least one of said at least two parts further comprises at least one passive stopper.

9. (currently amended) The method of ~~any one of the previous claims~~claim 8 wherein at least one of said at least two parts further comprises three non-colinear passive stoppers.

10. (currently amended) The method according to ~~any one of claims 1 to 9~~claim 1 wherein said glue is electrically conductive.

11. (currently amended) The method according to ~~any one of claims 1 to 9 of claim 1~~ wherein said glue is made of soldering alloy.

12. (currently amended) The method of ~~any one of claims 1 to 11~~claim 1 wherein the volume of said liquid glue is predetermined according to the shapes of the pads of said at least one pair of pads.

13. (currently amended) The method of ~~any one of the previous claims~~claim 1 wherein the volume of said liquid glue is predetermined according to the distance that must be set between said first and second parts.

14. (currently amended) The method of ~~any one of the previous claims~~claim 1 further comprising the step of applying a mechanical force on one of said first and second parts, said force being approximately orthogonal to the pads of said at least one pair of pads.

15. (currently amended) The method of ~~any one of the previous claims~~ claim 1 further comprising the step of hardening said liquid glue,
~~-hardening said liquid glue.~~

16. (original) The method of claim 15 wherein said step of hardening said glue comprises a cooling step.
